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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/767,764	01/29/2004	Max F. Hineman	2269-5925US (03-0290.00/U	5543
24247	7590 06/07/2006		EXAM	INER
TRASK BRITT P.O. BOX 2550			QUINTO,	KEVIN V
	CITY, UT 84110		ART UNIT	PAPER NUMBER
	•	•	2826	

DATE MAILED: 06/07/2006

Please find below and/or attached an Office communication concerning this application or proceeding.

	Application No.	Applicant(s)				
	10/767,764	HINEMAN ET AL.				
Office Action Summary	Examiner	Art Unit				
	Kevin Quinto	2826				
The MAILING DATE of this communication appears on the cover sheet with the correspondence address Period for Reply						
A SHORTENED STATUTORY PERIOD FOR REPL WHICHEVER IS LONGER, FROM THE MAILING D - Extensions of time may be available under the provisions of 37 CFR 1.1 after SIX (6) MONTHS from the mailing date of this communication. - If NO period for reply is specified above, the maximum statutory period - Failure to reply within the set or extended period for reply will, by statute Any reply received by the Office later than three months after the mailin earned patent term adjustment. See 37 CFR 1.704(b).	ATE OF THIS COMMU 136(a). In no event, however, may will apply and will expire SIX (6) & a. cause the application to become	NICATION. y a reply be timely filed MONTHS from the mailing date of this communication. EABANDONED (35 U.S.C. § 133)				
Status						
1) Responsive to communication(s) filed on 17 h	<u>1arch 2006</u> .					
•	, —					
3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is						
closed in accordance with the practice under Ex parte Quayle, 1935 C.D. 11, 453 O.G. 213.						
Disposition of Claims						
 4) Claim(s) 1-33 is/are pending in the application 4a) Of the above claim(s) is/are withdra 5) Claim(s) 1-25 is/are allowed. 6) Claim(s) 26-33 is/are rejected. 7) Claim(s) is/are objected to. 8) Claim(s) are subject to restriction and/o 	wn from consideration.					
Application Papers						
9) The specification is objected to by the Examine 10) The drawing(s) filed on is/are: a) acc Applicant may not request that any objection to the Replacement drawing sheet(s) including the correct 11) The oath or declaration is objected to by the Example 11.	epted or b) objected drawing(s) be held in abe tion is required if the drawi	vance. See 37 CFR 1.85(a). ng(s) is objected to. See 37 CFR 1.121(d).				
Priority under 35 U.S.C. § 119						
 12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f). a) All b) Some * c) None of: 1. Certified copies of the priority documents have been received. 2. Certified copies of the priority documents have been received in Application No 3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)). * See the attached detailed Office action for a list of the certified copies not received. 						
Attachment(s) 1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08) Paper No(s)/Mail Date	Paper N	v Summary (PTO-413) o(s)/Mail Date f Informal Patent Application (PTO-152)				

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DETAILED ACTION

Response to Arguments

1. Applicant's arguments with respect to claims 26-33 have been considered but are most in view of the new ground(s) of rejection.

Claim Rejections - 35 USC § 102

2. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.
- 3. Claim 26, 27, 31, and 32 are rejected under 35 U.S.C. 102(b) as being anticipated by Taguchi et al. (USPN 6,645,852 B1).
- 4. In reference to claims 26 and 31, Taguchi et al. (USPN 6,645,852 B1, hereinafter referred to as the "Taguchi" reference) discloses a structure which meets these claims. Figure 1B of Taguchi illustrates a metallic damascene structure which meets claims 26 and 31. Figure 1B of Taguchi illustrates a metallic damascene structure with a substrate (11) and a metallic layer (15) extending over at least a portion of a surface of the substrate (11). The metallic layer (15) includes an at least partially reversed oxidation injury (column 5, lines 15-67 and column 6, lines 1-36). An insulating layer (17) extends over at least a portion of the metallic layer (15). A damascene opening extends through at least a portion of the insulating layer (17) and exposes at least a

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portion of the metallic layer (15). The at least a portion of the metallic layer (15) exposed through the damascene opening comprises the at least partially reversed oxidation injury (column 5, lines 15-67 and column 6, lines 1-36) of the metallic layer (15). There is a metallic plug (26) in the damascene opening and it is in electrical connection with the metallic layer (15).

5. With regard to claims 27 and 32, Taguchi discloses that the metallic damascene structure of figure 1B is to be used in an electronic device (abstract).

Claim Rejections - 35 USC § 103

- 6. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 7. Claim 28 is rejected under 35 U.S.C. 103(a) as being unpatentable over of Taguchi et al. (USPN 6,645,852 B1) in view of Kitani (USPN 6,424,042 B1) and further in view of Oashi et al. (United States Patent Application Publication No. US 2002/0030215 A1).
- 8. With regard to claim 28, Taguchi does not disclose the use of the damascene structure in a memory device. However the use of damascene structures in memory devices is well known in the art. Kitani (USPN 6,424,042 B1) discloses that using damascene structures in memory devices has the benefit of providing an increased operation speed (column 1, lines 14-19). Oashi et al. (United States Patent Application

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Publication No. US 2002/0030215 A1, hereinafter referred to as the "Oashi" reference) discloses that a faster operation speed is a known goal in the art (p.1, paragraph 5). In view of Kitani and Oashi, it would therefore be obvious to implement the damascene structure of Taguchi in a memory device.

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- 9. Claims 29, 30, and 33 are rejected under 35 U.S.C. 103(a) as being unpatentable over Chen et al. (USPN 6,885,080 B2) in view of Oashi et al. (United States Patent Application Publication No. US 2002/0030215 A1) and further in view of Taguchi et al. (USPN 6,645,852 B1).
- 10. In reference to claims 29, 30, and 33, Chen et al. (USPN 6,885,080 B2, hereinafter referred to as the "Chen" reference) discloses an electronic device with a microprocessor and an embedded dynamic random access memory (DRAM) or integrated circuit coupled to it on the same substrate (column 1, lines 12-16). Chen does not disclose the use of damascene structures for DRAM. However the use of damascene structures in a DRAM is well known in the art. Oashi (United States Patent Application Publication No. US 2002/0030215 A1, hereinafter referred to as the "Oashi" reference) discloses a DRAM with damascene structures in figure 22. Oashi discloses that such a DRAM has a small size (p.1, paragraph 22) which is desirable in the art (p.2, paragraph 7). In view of Oashi, it would therefore be obvious to implement a DRAM with damascene structures in the electronic device of Chen. Neither Oashi nor Chen discloses the use of a metallic damascene structure with a partially reversed oxidation injury in a metallic layer. However the use of such a structure is known in the art.

 Taguchi et al. (USPN 6,645,852 B1) discloses a metallic damascene structure. Figure

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1B of Taguchi illustrates a metallic damascene structure with a substrate (11) and a metallic layer (15) extending over at least a portion of a surface of the substrate (11). The metallic layer (15) includes an at least partially reversed oxidation injury (column 5. lines 15-67 and column 6, lines 1-36). An insulating layer (17) extends over at least a portion of the metallic layer (15). A damascene opening extends through at least a portion of the insulating layer (17) and exposes at least a portion of the metallic layer (15). The at least a portion of the metallic layer (15) exposed through the damascene opening comprises the at least partially reversed oxidation injury (column 5, lines 15-67 and column 6, lines 1-36) of the metallic layer (15). There is a metallic plug (26) in the damascene opening and it is in electrical connection with the metallic layer (15). Taguchi discloses that this damascene structure has the advantage of providing a contact structure with low resistance and high reliability (column 7, lines 6-16). The removal of copper oxide in a contact structure in order to attain low resistance and high reliability are known goals in the art (column 1, lines 42-48, column 7, lines 6-16). In view of Taguchi, it would therefore be obvious to implement such a damascene structure in the electronic device of Chen constructed in view of Oashi in order to attain the benefit of a low resistance damascene structure.

Allowable Subject Matter

11. Claims 1-25 were allowed in a previous Office action.

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Conclusion

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Any inquiry concerning this communication or earlier communications from the examiner should be directed to Kevin Quinto whose telephone number is (571) 272-1920. The examiner can normally be reached on M-F 8AM-5PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Nathan Flynn can be reached on (571) 272-1915. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

KVQ